



2014
#11d Amdt.
M. Brunson
8/15/02
PATENT

Atty. Docket No. 29347/990488

IN THE UNITED STATES PATENT
AND TRADEMARK OFFICE

Applicants: Jeun et al.)	I hereby certify that this
)	paper is being deposited
Serial No.: 09/677,558)	with the United States
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Filed: September 29, 2000)	class mail, postage prepaid,
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For: Semiconductor Power)	
Module Having an)	Commissioner for Patents,
Electrically Insulating)	Washington, D.C. 20231, on:
Heat Sink and Method of)	
Manufacturing the Same)	Date: August 5, 2002
)	
Group Art Unit: 2814)	
)	
Examiner: DiLinh Nguyen)	James P. Zeller
)	Reg. No. 28,491

AMENDMENT "A"

COMMISSIONER FOR PATENTS
Washington, DC 20231

Sir:

In response to the official action mailed on May 3, 2002,
please enter the following amendments and consider the
accompanying remarks.

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